DATA SHEET

BSP230
P-channel enhancement mode vertical D-MOS transistor

Product specification
Supersedes data of 1997 Jun 17
File under Discrete Semiconductors, SC13b

1997 Oct 21

Philips Semiconductors

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P-channel enhancement mode vertical D-MOS transistor

BSP230

FEATURES

- Direct interface to C-MOS, TTL, etc.
- High-speed switching
- No secondary breakdown.

APPLICATIONS

- Line current interruptor in telephone sets
- Relay, high speed and line transformer drivers.

DESCRIPTION

P-channel enhancement mode vertical D-MOS transistor in a SOT223 plastic SMD package.

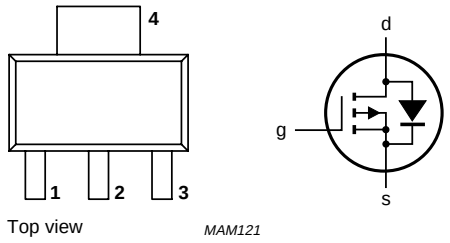


Fig.1 Simplified outline and symbol.

PINNING - SOT223

PIN	SYMBOL	DESCRIPTION
1	g	gate
2	d	drain
3	s	source
4	d	drain

CAUTION
The device is supplied in an antistatic package. The gate-source input must be protected against static discharge during transport or handling.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{DS}	drain-source voltage (DC)		–	–300	V
V_{GSO}	gate-source voltage (DC)	open drain	–	±20	V
V_{GSth}	gate-source threshold voltage	I_D = –1 mA; V_{DS} = V_{GS}	–1.95	–2.8	V
I_D	drain current (DC)		–	–210	mA
R_{DSon}	drain-source on-state resistance	I_D = –170 mA; V_{GS} = –10 V	–	17	Ω
P_{tot}	total power dissipation	$T_{amb} \leq 25$ °C	–	1.5	W

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{DS}	drain-source voltage (DC)		–	–300	V
V_{GSO}	gate-source voltage (DC)	open drain	–	±20	V
I_D	drain current (DC)		–	–210	mA
I_{DM}	peak drain current		–	–0.75	A
P_{tot}	total power dissipation	$T_{amb} \leq 25$ °C; note 1	–	1.5	W
T_{stg}	storage temperature		–65	+150	°C
T_j	operating junction temperature		–	150	°C

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th\ j\text{-}a}$	thermal resistance from junction to ambient	note 1	83.3	K/W

Note to the Limiting values and Thermal characteristics

1. Device mounted on an epoxy printed-circuit board, 40 × 40 × 1.5 mm; mounting pad for drain lead minimum 6 cm^2.

CHARACTERISTICS

T_j = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{(BR)DSS}$	drain-source breakdown voltage	V_{GS} = 0; I_D = –10 μA	–300	–	–	V
V_{GSth}	gate-source threshold voltage	V_{DS} = V_{GS}; I_D = –1 mA	–1.95	–	–2.8	V
I_{DSS}	drain-source leakage current	V_{GS} = 0; V_{DS} = –240 V	–	–	–100	nA
I_{GSS}	gate leakage current	V_{GS} = ±20 V; V_{DS} = 0	–	–	±100	nA
R_{DSon}	drain-source on-state resistance	V_{GS} = –10 V; I_D = –170 mA	–	–	17	Ω
$\lvert y_{fs} \rvert$	forward transfer admittance	V_{DS} = –25 V; I_D = –170 mA	100	–	–	mS
C_{iss}	input capacitance	V_{GS} = 0; V_{DS} = –25 V; f = 1 MHz	–	60	90	pF
C_{oss}	output capacitance	V_{GS} = 0; V_{DS} = –25 V; f = 1 MHz	–	15	30	pF
C_{rss}	reverse transfer capacitance	V_{GS} = 0; V_{DS} = –25 V; f = 1 MHz	–	5	15	pF
Switching times (see Figs 2 and 3)						
t_{on}	turn-on time	V_{GS} = 0 to –10 V; V_{DD} = –50 V; I_D = –250 mA	–	5	10	ns
t_{off}	turn-off time	V_{GS} = –10 to 0 V; V_{DD} = –50 V; I_D = –250 mA	–	15	30	ns

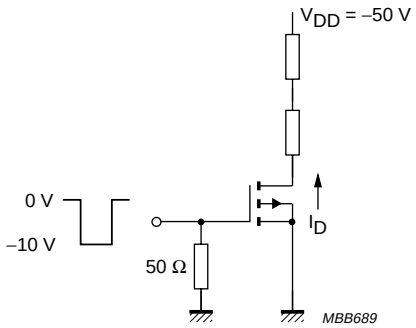


Fig.2 Switching time test circuit.

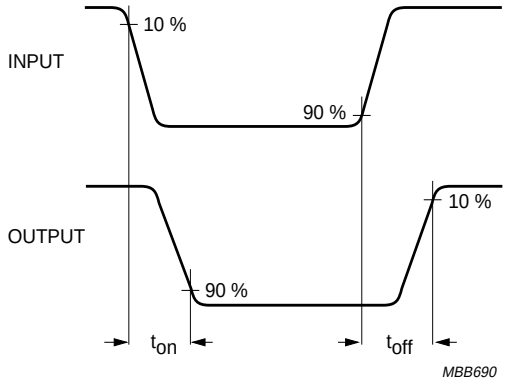


Fig.3 Input and output waveforms.

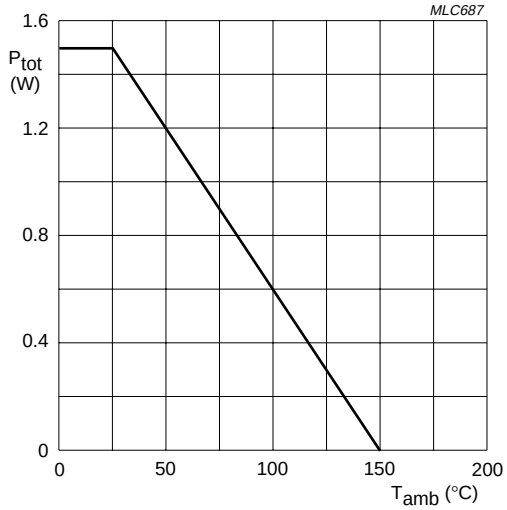
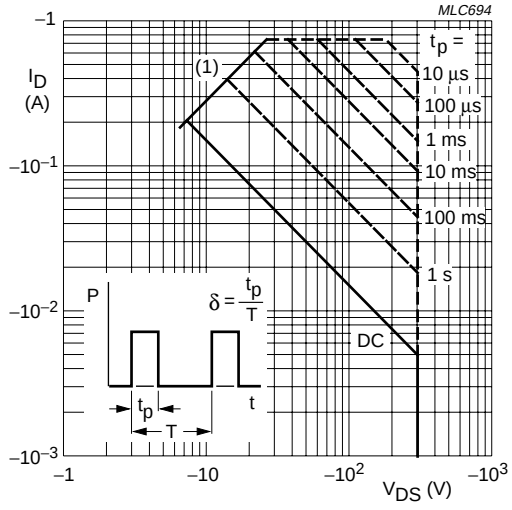
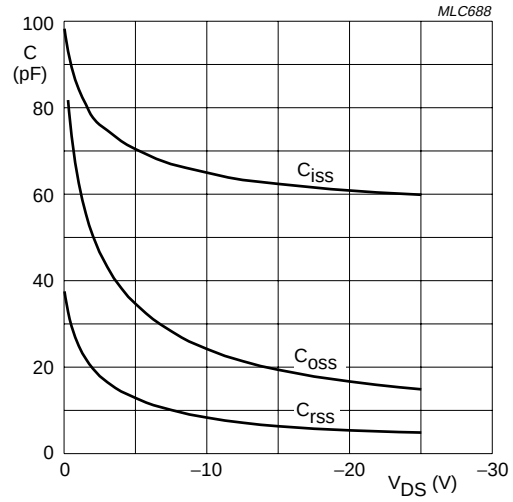


Fig.4 Power derating curve.



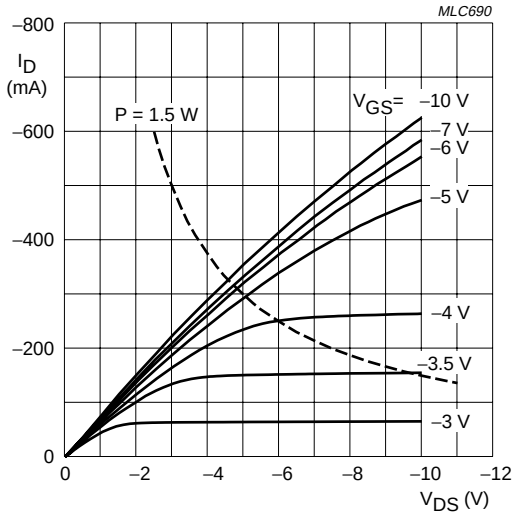
δ = 0.01.
T_{amb} = 25 °C.
(1) R_{DSon} limitation.

Fig.5 DC SOAR.



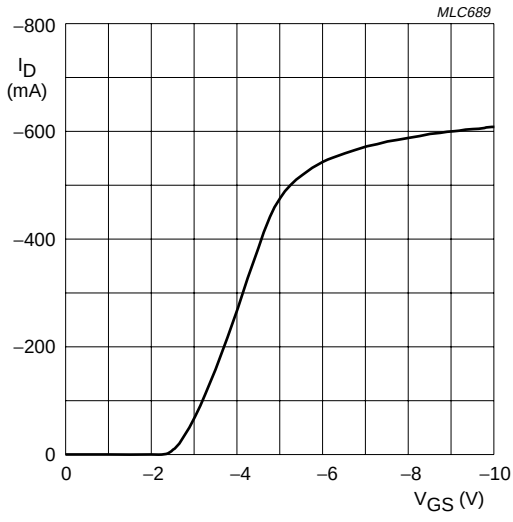
V_{GS} = 0.
T_j = 25 °C.
f = 1 MHz.

Fig.6 Capacitance as a function of drain source voltage; typical values.



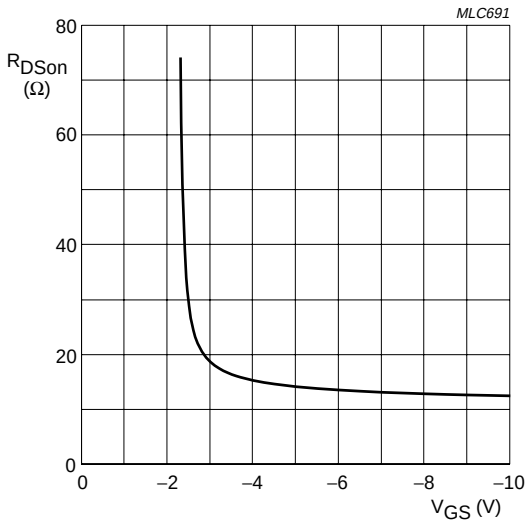
T_j = 25 °C.

Fig.7 Typical output characteristics.



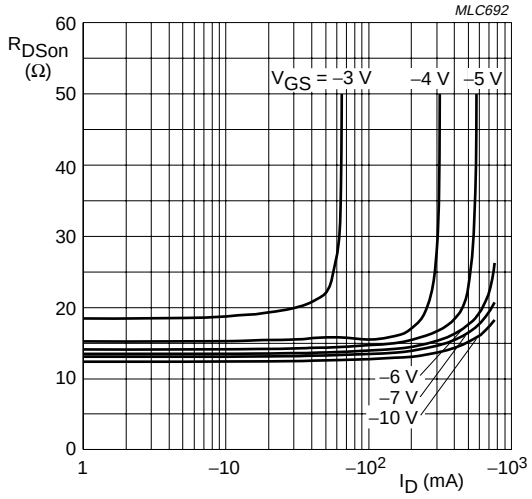
V_{DS} = −25 V.
T_j = 25 °C.

Fig.8 Typical transfer characteristics.



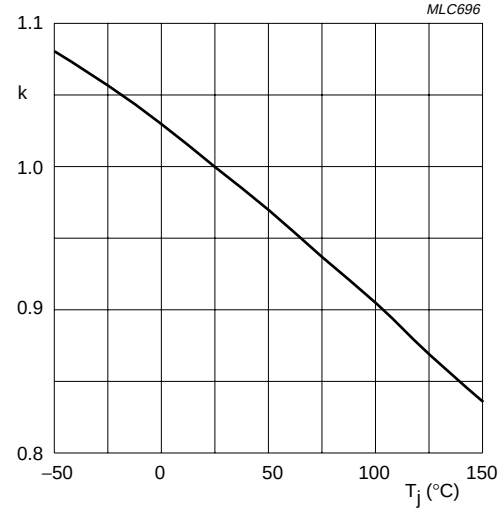
I_D = −170 mA.
T_j = 25 °C.

Fig.9 Drain-source on-state resistance as a function of gate-source voltage; typical values.



T_j = 25 °C.

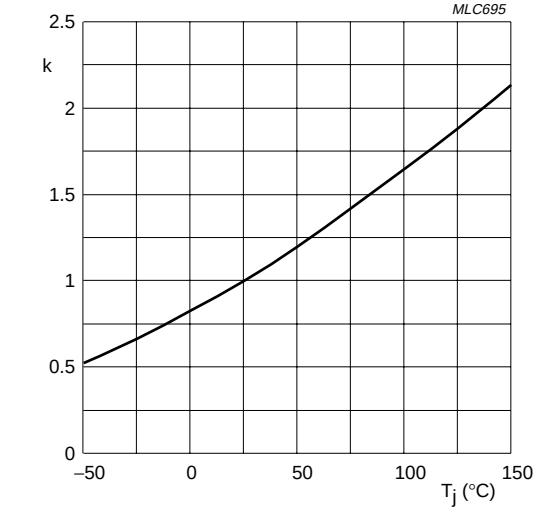
Fig.10 Drain-source on-state resistance as a function of drain current; typical values.



$$k = \frac{V_{GSth} \text{ at } T_j}{V_{GSth} \text{ at } 25°C}$$

Typical V_{GSth} at I_D = −1 mA; V_{DS} = V_{GS}.

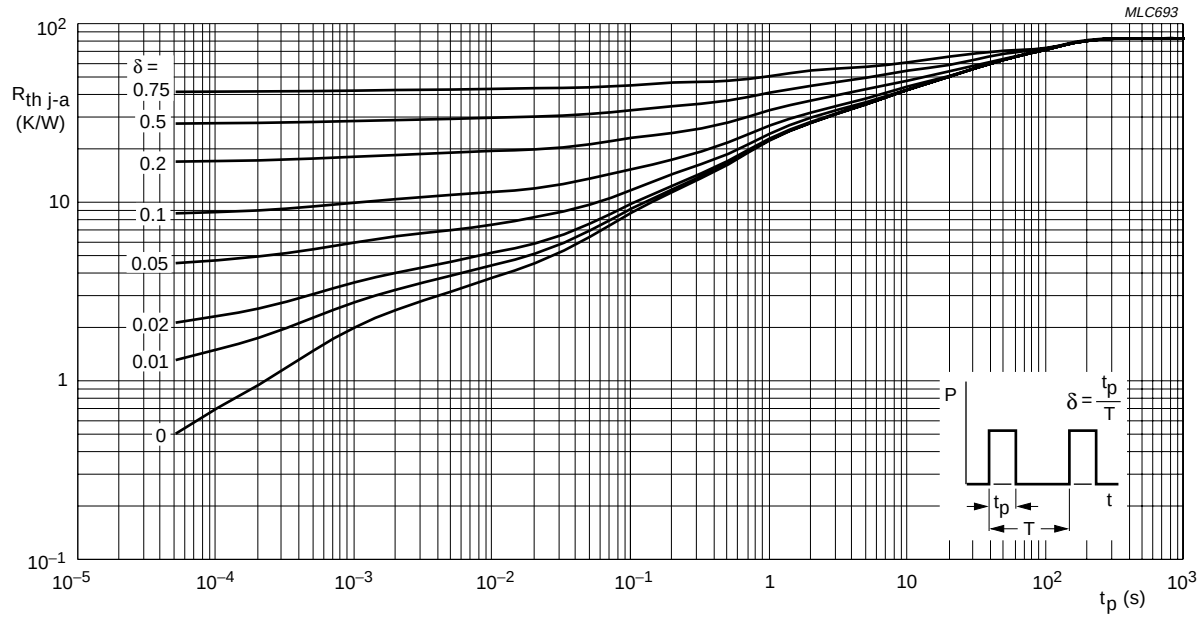
Fig.11 Temperature coefficient of gate-source threshold voltage.



$$k = \frac{R_{DSon} \text{ at } T_j}{R_{DSon} \text{ at } 25\ °C}$$

Typical R_{DSon} at I_D = −170 mA; V_{GS} = −10 V.

Fig.12 Temperature coefficient of drain-source on-state resistance.

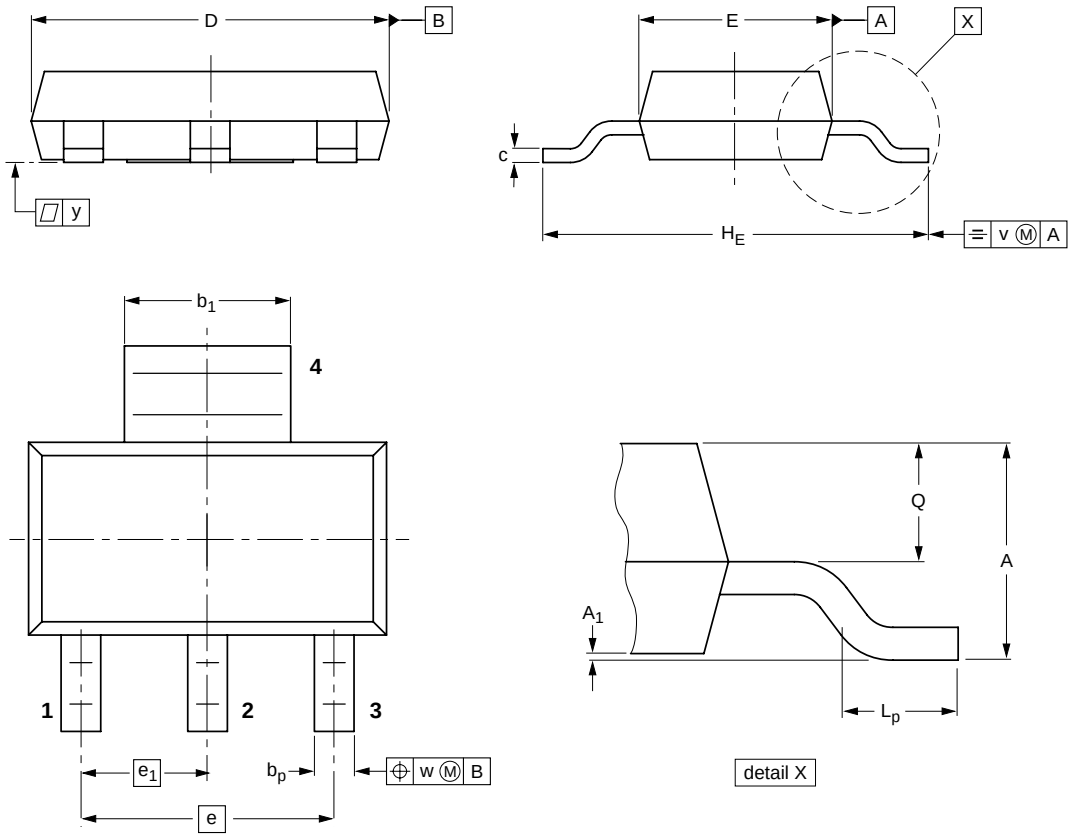


T_{amb} = 25 °C.

Fig.13 Transient thermal resistance from junction to ambient as a function of pulse time; typical values.

PACKAGE OUTLINE

Plastic surface mounted package; collector pad for good heat transfer; 4 leads **SOT223**



DIMENSIONS (mm are the original dimensions)

UNIT	A	A_1	b_p	b_1	c	D	E	e	e_1	H_E	L_p	Q	v	w	y
mm	1.8 1.5	0.10 0.01	0.80 0.60	3.1 2.9	0.32 0.22	6.7 6.3	3.7 3.3	4.6	2.3	7.3 6.7	1.1 0.7	0.95 0.85	0.2	0.1	0.1

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT223						~~96-11-11~~ 97-02-28

DEFINITIONS

Data Sheet Status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	

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